

Ceramic

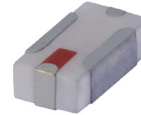
Bandpass Filter

BFCN-2500+

50Ω 2100 to 2900 MHz

The Big Deal

- LTCC construction
- Temperature stable from -55 to +100°C
- Small size (0.126 x .063 X .037")



CASE STYLE: FV1206-4

Product Overview

The BFCN-2500+ LTCC bandpass filter covers the 2100 to 2900 MHz passband with 2 dB passband insertion loss and 20 dB upper/lower stopband rejection. This model handles up to 2.5W RF input power and provides a wide operating temperature range from -55 to +100°C. Utilizing LTCC multi-layer construction, the filter achieves excellent repeatability of performance and comes in a tiny 1206 ceramic package with wraparound terminations, minimizing performance variations due to parasitics and saving space in dense PCB layouts.

Key Features

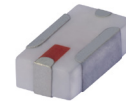
Feature	Advantages
LTCC Construction	Provides a rugged package well suited for tough environments such as high humidity and temperature extremes.
Tiny size (0.126 x .063 x .037")	Saves space in dense circuit boards and minimizes the effects of parasitics.
Wrap-around terminations	Provides excellent solderability and easy visual inspection
Wide operating temperature range, -55 to +100°C	Enables reliable performance in extreme environments

Ceramic

Bandpass Filter

50Ω 2100 to 2900 MHz

BFCN-2500+



Generic photo used for illustration purposes only

CASE STYLE: FV1206-4

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications



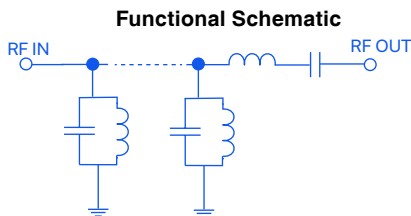
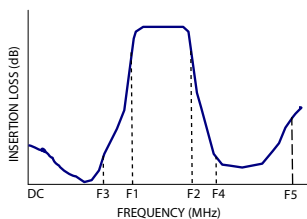
Features

- Good VSWR, 1.8:1 typ. @ passband
- Small size(0.126 x .063 x .037)
- Temperature stable
- LTCC construction

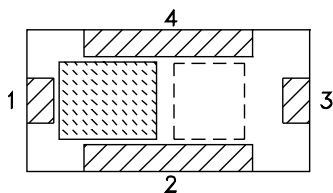
Applications

- Harmonic rejection
- Transmitters / Receivers

Specification Definition



Top View



Pad Connections

Input	1
Output	3
Ground	2,4

Electrical Specifications^{1,2} at 25°C

Parameter	F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Pass Band	Center Frequency	—	—	2500	—	MHz
	Insertion Loss	F1 - F2	—	2	3.7	dB
	VSWR	F1 - F2	—	1.8	2.6	:1
Stop Band, Lower	Insertion Loss	DC - F3	—	20	—	dB
	VSWR	DC - F3	—	20	—	:1
Stop Band, Upper	Insertion Loss	F4 - F5	—	20	—	dB
	VSWR	F4 - F5	—	15	—	:1

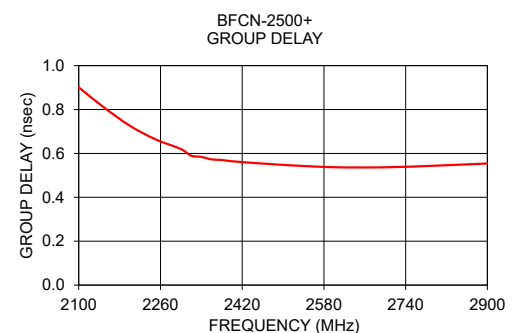
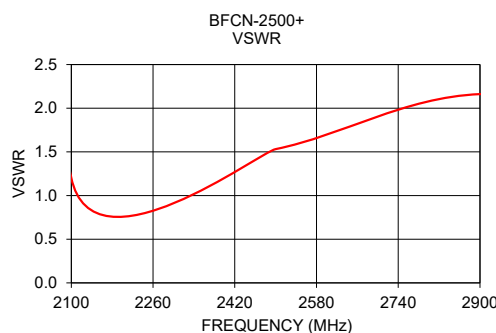
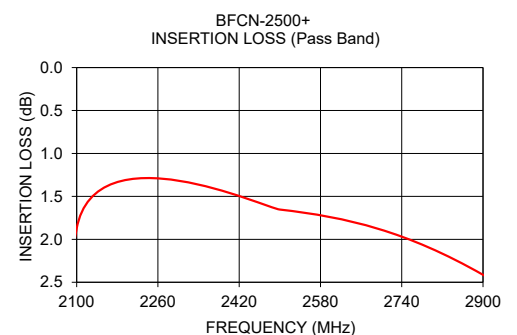
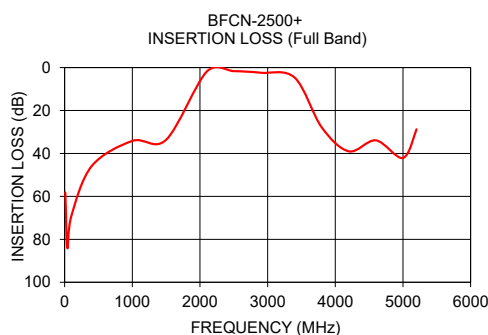
1. Measured on Mini-Circuits Characterization Test Board TB-824+.

2. This filter is not intended for use as a DC Blocking circuit element. In Application where DC voltage is present at either input or output ports, blocking capacitors are required at the corresponding RF port.

Maximum Ratings

Operating Temperature	-55°C to +100°C
Storage Temperature	-55°C to +100°C
RF Power Input*	2.5W at 25°C

*Passband rating, derate linearly to 0.7W at 100°C ambient
Permanent damage may occur if any of these limits are exceeded.



Mini-Circuits

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REV. B
ECO-023234
ED-17087
BFCN-2500+
241004

Bandpass Filter

BFCN-2500+

Full Band Performance

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)	Frequency (MHz)	Insertion Loss (dB)	Group Delay (nsec)
10	58.18	79.99	2100	1.88	0.90
40	84.01	78.80	2150	1.70	0.81
100	69.04	74.42	2200	1.63	0.73
400	45.88	61.11	2250	1.60	0.66
1000	34.16	43.74	2300	1.60	0.62
1500	33.62	29.10	2320	1.60	0.59
2100	1.88	1.20	2340	1.60	0.58
2500	1.65	1.53	2360	1.61	0.57
2900	2.41	2.16	2380	1.61	0.57
3400	4.69	1.76	2400	1.62	0.56
3800	27.88	14.98	2500	1.65	0.55
4200	39.01	20.59	2600	1.74	0.54
4600	33.90	20.73	2700	1.89	0.54
5000	42.09	11.56	2800	2.11	0.54
5200	28.75	6.04	2900	2.41	0.55

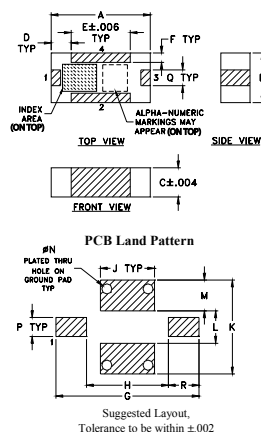
Pass Band Performance

Pad Connections

Input	1
Output	3
Ground	2,4

Product Marking: MW

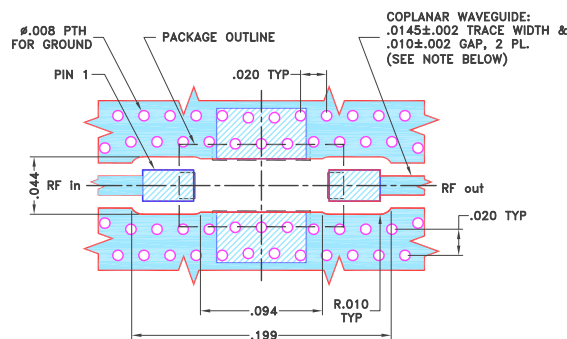
Outline Drawing



Outline Dimensions (inch mm)

A	B	C	D	E	F	G	H	J
.126	.063	.037	.026	.075	.012	.182	.104	.069
3.20	1.60	0.94	0.66	1.91	0.30	4.62	2.64	1.75
K	L	M	N	P	Q	R		wt
.119	.041	.039	.013	.024	.020	.039		grams
3.02	1.04	0.99	0.33	0.61	0.51	0.99		.020

Demo Board MCL P/N: TB-824+ Suggested PCB Layout (PL-454)



NOTES:

- TRACE WIDTH PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .0066"±.0007". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

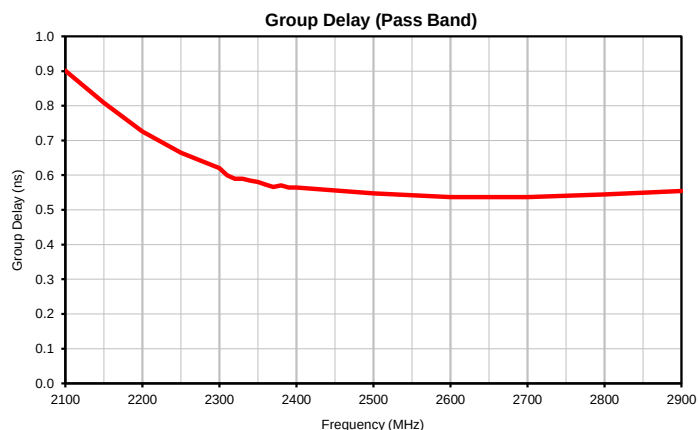
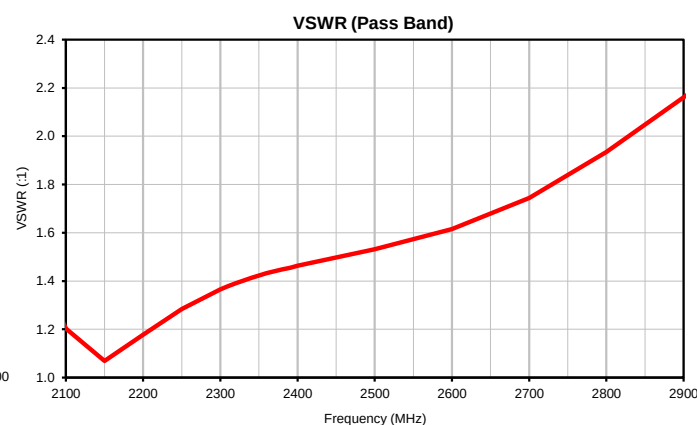
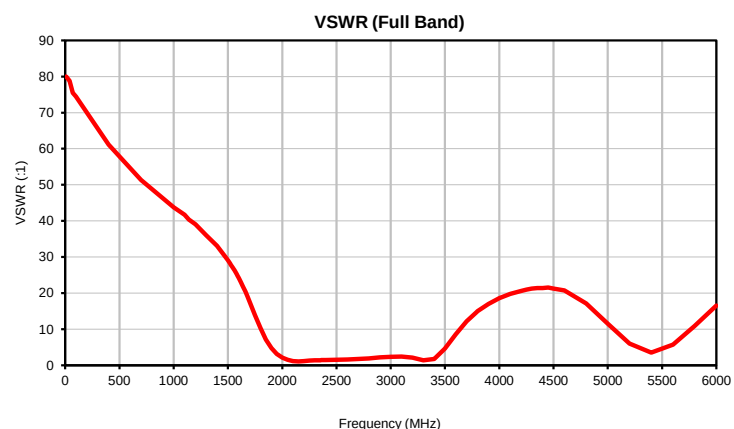
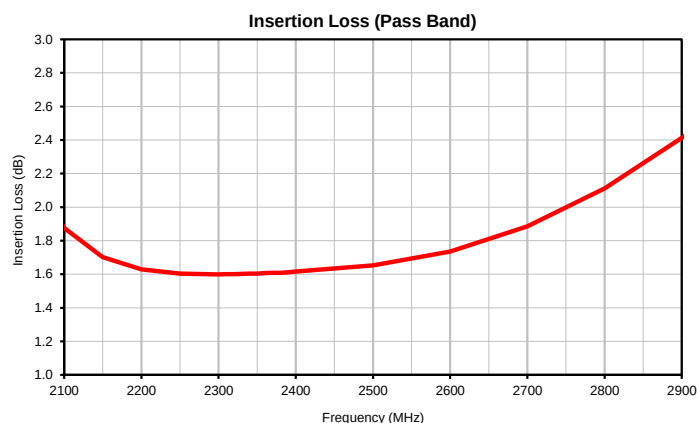
NOTES

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- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
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Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	VSWR (:1)	FREQUENCY (MHz)	GROUP DELAY (ns)
10	58.18	79.99	2100	0.90
40	84.01	78.80	2150	0.81
70	74.15	75.47	2200	0.73
100	69.04	74.42	2250	0.66
400	45.88	61.11	2300	0.62
700	37.83	51.38	2310	0.60
1000	34.16	43.74	2320	0.59
1100	33.94	41.71	2330	0.59
1140	34.09	40.41	2340	0.58
1200	34.67	39.04	2350	0.58
1300	37.56	36.07	2360	0.57
1400	53.82	33.11	2370	0.57
1500	33.62	29.10	2380	0.57
1510	32.40	28.72	2390	0.56
1520	31.26	28.21	2400	0.56
1530	30.20	27.76	2500	0.55
1540	29.19	27.23	2600	0.54
1550	28.24	26.76	2700	0.54
1560	27.33	26.33	2800	0.54
1570	26.45	25.84	2900	0.55
1580	25.60	25.28		
1590	24.78	24.75		
1600	23.98	24.20		
1620	22.45	23.00		
1640	21.00	21.77		
1660	19.60	20.45		
1680	18.25	19.04		
1700	16.96	17.59		
1750	13.86	13.89		
1800	10.97	10.32		
1850	8.32	7.16		
1900	6.03	4.77		
1950	4.24	3.14		
2000	3.00	2.13		
2050	2.26	1.54		
2100	1.88	1.20		
2150	1.70	1.07		
2200	1.63	1.18		
2250	1.60	1.28		
2300	1.60	1.37		
2310	1.60	1.38		
2320	1.60	1.39		
2330	1.60	1.40		
2340	1.60	1.41		
2350	1.60	1.42		
2360	1.61	1.43		
2370	1.61	1.44		
2380	1.61	1.45		
2390	1.61	1.46		
2400	1.62	1.46		
2500	1.65	1.53		
2600	1.74	1.61		
2700	1.89	1.74		
2800	2.11	1.93		
2900	2.41	2.16		
3000	2.74	2.38		
3100	2.99	2.44		
3200	3.06	2.15		
3300	3.14	1.42		
3400	4.69	1.76		
3500	9.37	4.60		
3600	15.42	8.62		
3700	21.53	12.21		
3790	27.22	14.71		
3800	27.88	14.98		
3900	35.34	16.96		
4000	47.47	18.59		
4100	44.56	19.79		
4200	39.01	20.59		
4250	37.54	20.93		
4300	36.44	21.25		
4350	35.62	21.42		
4400	35.02	21.41		
4450	34.54	21.55		
4500	34.21	21.22		
4600	33.90	20.73		
4800	35.08	17.16		
5000	42.09	11.56		
5200	28.75	6.04		
5400	19.80	3.53		
5600	16.80	5.76		
5800	16.08	10.89		
6000	15.53	16.54		

Typical Performance Curves



DEVICE ORIENTATION IN T&R

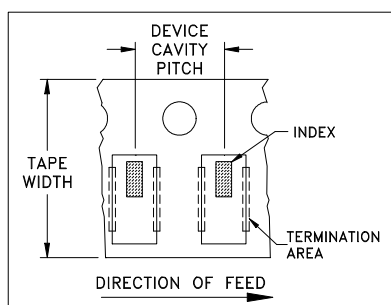


ILLUSTRATION 1

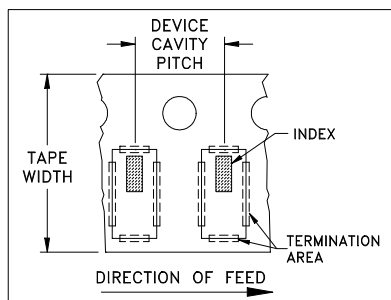


ILLUSTRATION 2

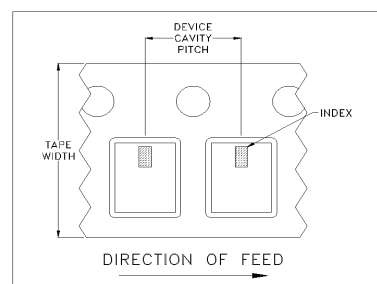


ILLUSTRATION 3

Applicable Case Styles

FV1206-1
FV1206-3

Applicable Case Styles

FV1206-4
FV1206-5
FV1206-6
FV1206-7
FV1206-9

Applicable Case Styles

FV1206-11
FV1206-12
GE0805C-18
NL1008C-6
NL1008C-7
NL1008C-9
NL1008C-10
NL1008C-12

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

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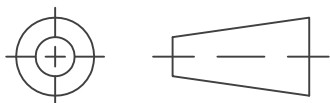


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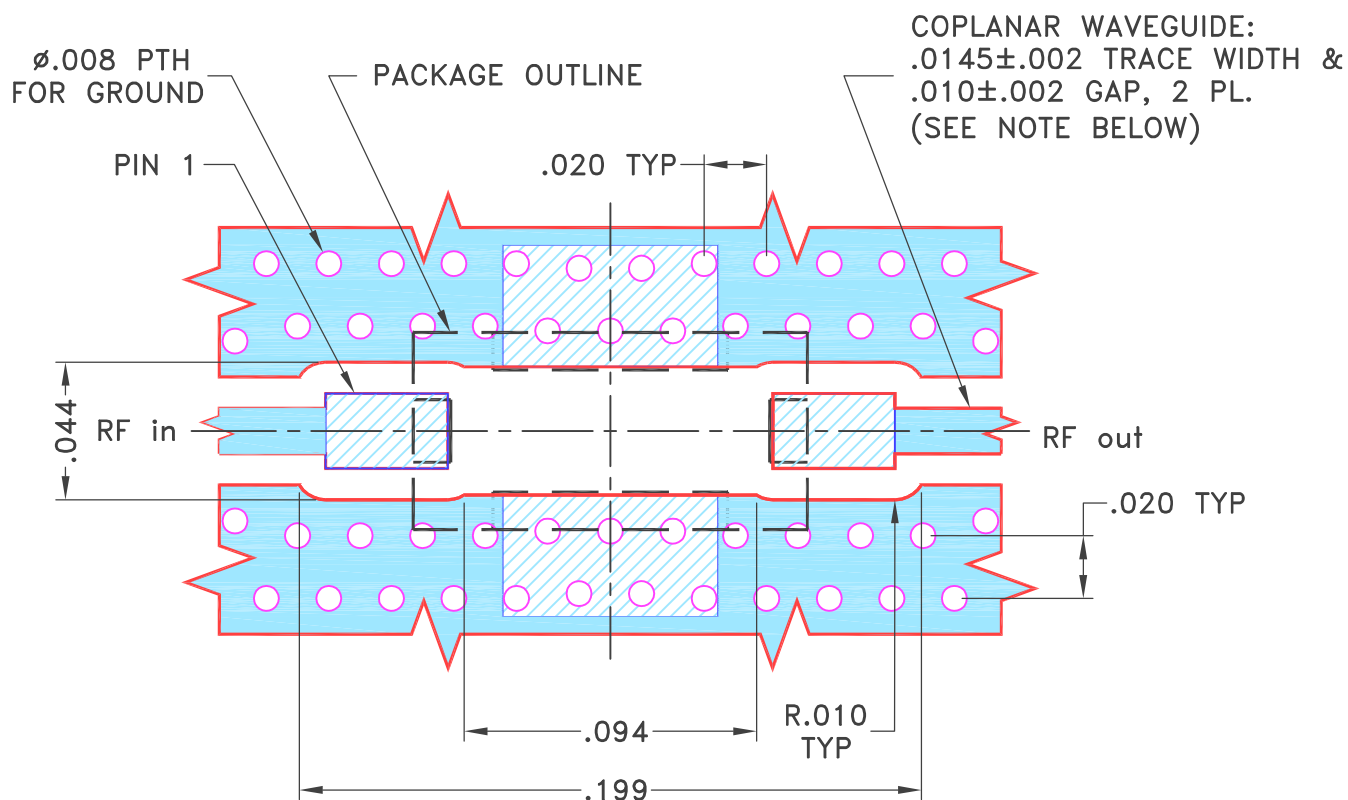
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M152168	NEW RELEASE	07/31/15	ITG	AVB

SUGGESTED MOUNTING CONFIGURATION
FOR FV1206-4 CASE STYLE, "04FL01" PIN CODE

**NOTES:**

- TRACE WIDTH PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS $.0066 \pm .0007$ ". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

DRAWN

ITG

07/30/15

CHECKED

GF

07/31/15

APPROVED

AVB

07/31/15



Mini-Circuits®

13 Neptune Avenue
Brooklyn NY 11235

PL, 04FL01, FV1206-4, TB-824+

SIZE
A

CODE IDENT
15542

DRAWING NO:

98-PL-454

REV:

OR

FILE: **98PL454**

SCALE:

16:1

SHEET:

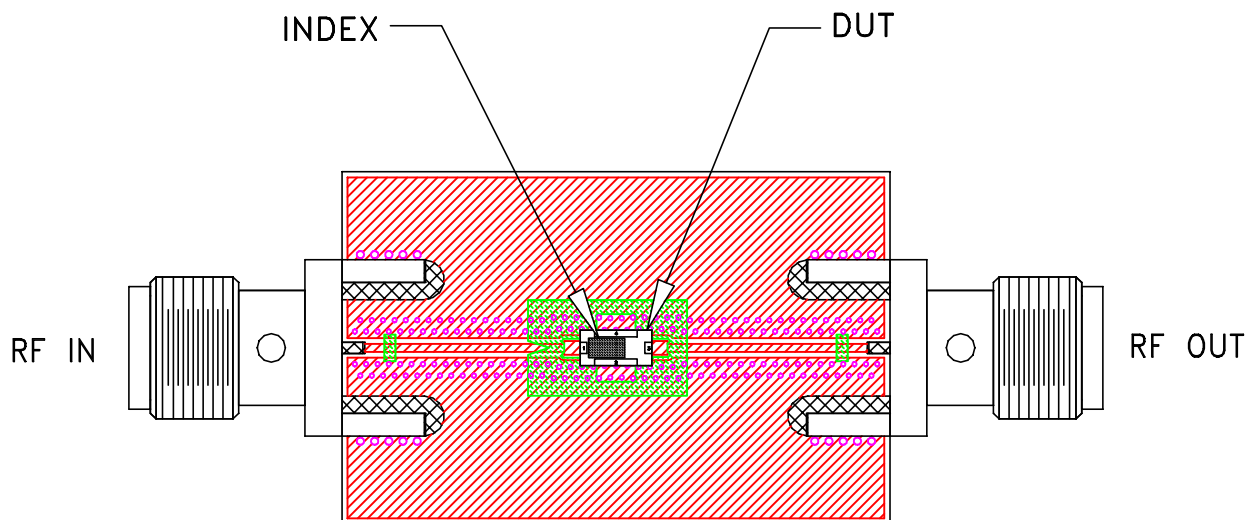
1 OF 1

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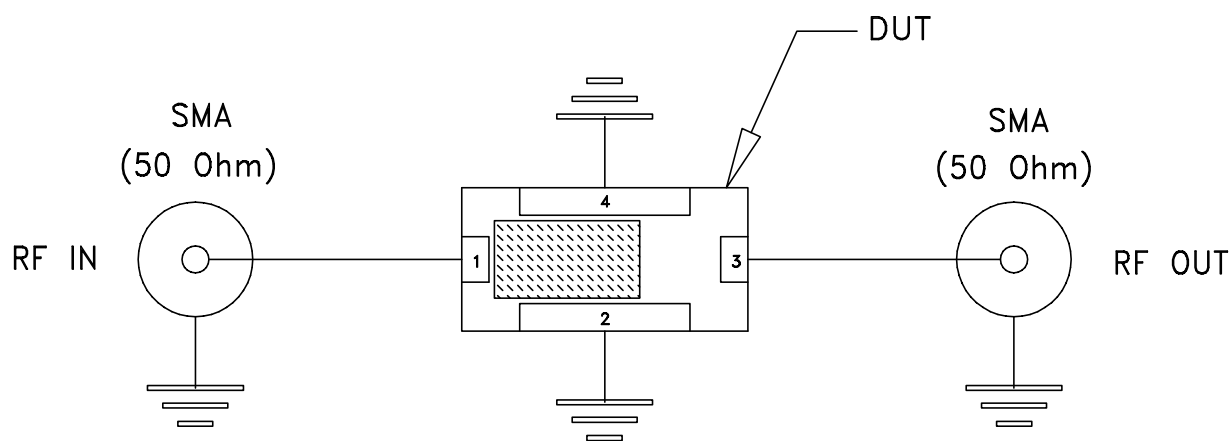
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ASHEETA1.DWG REV:A DATE:01/12/95

Evaluation Board and Circuit



TB-824+



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.0066 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215